



IFW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Applicant:	§	Art Unit:	2814
Ilya Karpov et al.	§		
	§	Examiner:	Long Pham
Serial No.: 10/822,361	§		
	§	Docket:	ITL.0835D1US
Filed: April 12, 2004	§		P14730D
	§		
For: Fabricating Deeper and Shallower	§	Assignee:	Intel Corporation
Trenches in Semiconductor Structures	§		
	§	Conf. No.	3077

Mail Stop **Amendment**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**RESPONSE TO PAPER NO. 09062005**

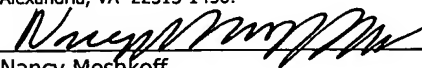
Sir:

In response to the Office Action mailed on September 12, 2005, please consider the following:

- *Claim Amendments*, which begin on page 2 of this document; and
- *Remarks*, which begin on page 3 of this document.

Date of Deposit: December 9, 2005

I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as **first class mail** with sufficient postage on the date indicated above and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

  
Nancy Meshkoff